

C3225X8R2A684M250AB

TDK Item Description : C3225X8R2A684MT****



Application & Main Feature

Commercial Grade (High Temperature Application)

Series

C3225 [EIA CC1210]



Dimensions

L 3.20mm +/-0.4mm
 W 2.50mm +/-0.3mm
 T 2.50mm +/-0.3mm
 B 0.20mm Min.
 G

Temperature Characteristic

X8R (-55 to 150 degC +/-15%)

Rated Voltage

2A (100Vdc)

Capacitance

680nF

Capacitance Tolerance

M (+/-20%)

Dissipation Factor

3% Max.

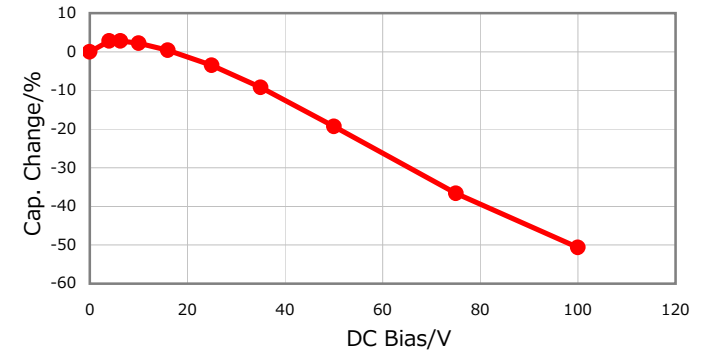
Insulation Resistance

735Mohm Min.

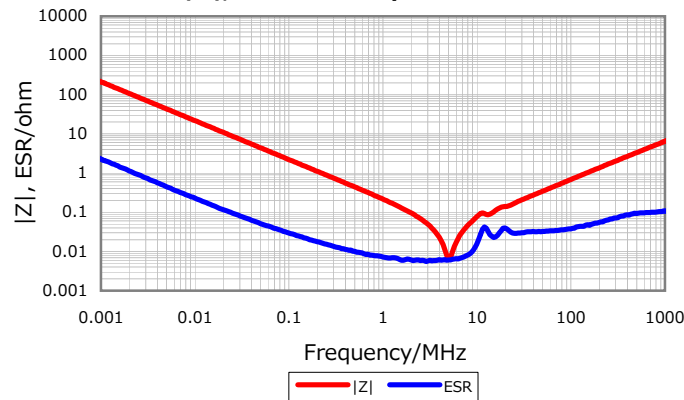
AEC-Q200

Not Applicable

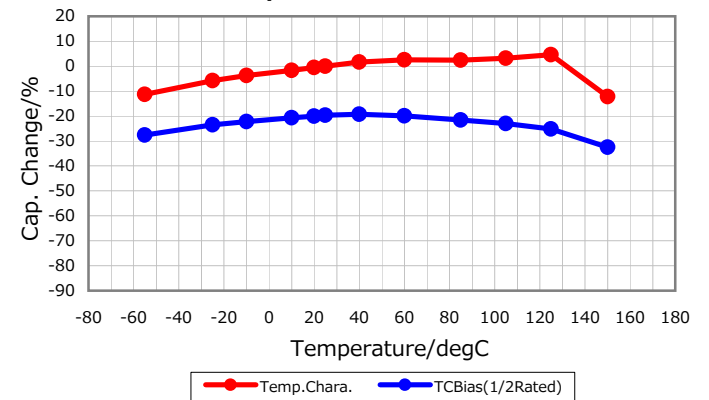
DC Bias Characteristic



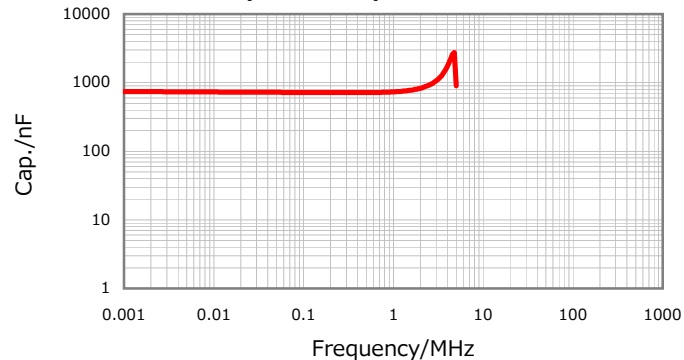
|Z|, ESR vs. Freq. Characteristics



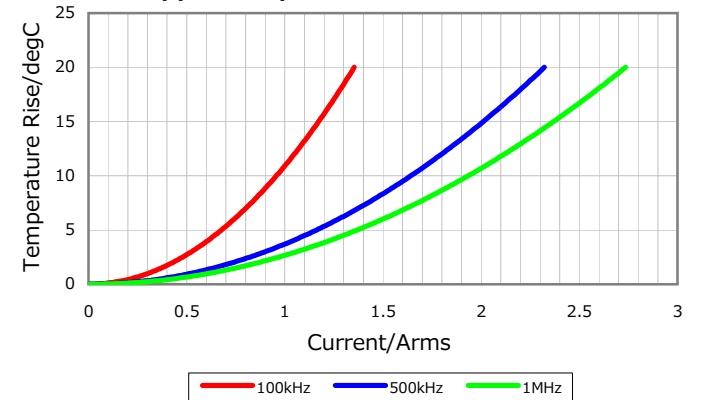
Temperature Characteristics



Cap. vs. Freq. Characteristic



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



⚠ All specifications are subject to change without notice.

January 4, 2016